

# BLF8G09LS-400PW; BLF8G09LS-400PGW

Power LDMOS transistor

Rev. 5 — 1 September 2015

AMPLEON

Product data sheet

## 1. Product profile

### 1.1 General description

400 W LDMOS power transistor for base station applications at frequencies from 716 MHz to 960 MHz.

**Table 1. Typical performance**

Typical RF performance at  $T_{case} = 25\text{ °C}$  in a common source class-AB production test circuit, tested on straight lead device.

| Test signal      | f<br>(MHz) | $I_{DQ}$<br>(mA) | $V_{DS}$<br>(V) | $P_{L(AV)}$<br>(W) | $G_p$<br>(dB) | $\eta_D$<br>(%) | ACPR <sub>5M</sub><br>(dBc) |
|------------------|------------|------------------|-----------------|--------------------|---------------|-----------------|-----------------------------|
| 2-carrier W-CDMA | 716 to 728 | 3400             | 28              | 95                 | 20.6          | 30              | -35 <a href="#">[1]</a>     |

[1] 3GPP test model 1; 64 DPCH; PAR = 8.4 dB at 0.01 % probability on CCDF; 10 MHz carrier spacing.

### 1.2 Features and benefits

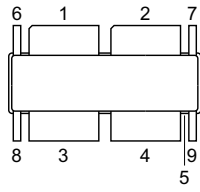
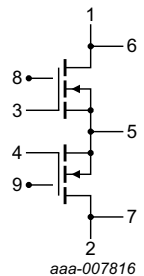
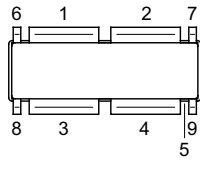
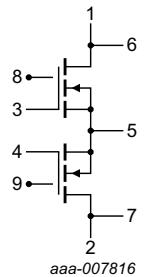
- Excellent ruggedness
- Device can operate with the supply current delivered through the video leads
- High efficiency
- Low thermal resistance providing excellent thermal stability
- Designed for broadband operation
- Lower output capacitance for improved performance in Doherty applications
- Decoupling leads to enable improved video bandwidth (45 MHz typical)
- Designed for low memory effects providing excellent pre-distortability
- Internally matched for ease of use
- Integrated ESD protection
- Design optimized for gull-wing
- Compliant to Directive 2002/95/EC, regarding Restriction of Hazardous Substances (RoHS)

### 1.3 Applications

- RF power amplifiers for base stations and multi carrier applications in the 716 MHz to 960 MHz frequency range

## 2. Pinning information

Table 2. Pinning

| Pin                                | Description | Simplified outline  | Graphic symbol   |
|------------------------------------|-------------|---|--|
| <b>BLF8G09LS-400PW (SOT1242B)</b>  |             |   |  |
| 1                                  | drain1      |   |   |
| 2                                  | drain2      |   |  |
| 3                                  | gate1       |   |  |
| 4                                  | gate2       |   |  |
| 5                                  | source      |   |  |
| 6                                  | decoupling1 |   |  |
| 7                                  | decoupling2 |   |  |
| 8                                  | n.c.        |   |  |
| 9                                  | n.c.        |   |  |
| <b>BLF8G09LS-400PGW (SOT1242C)</b> |             |   |  |
| 1                                  | drain1      |  |  |
| 2                                  | drain2      |   |  |
| 3                                  | gate1       |   |  |
| 4                                  | gate2       |   |  |
| 5                                  | source      |   |  |
| 6                                  | decoupling1 |   |  |
| 7                                  | decoupling2 |   |  |
| 8                                  | n.c.        |   |  |
| 9                                  | n.c.        |   |  |

[1] Connected to flange.

[2] Device can operate with the supply current delivered through the combined decoupling leads.

## 3. Ordering information

Table 3. Ordering information

| Type number      | Package |  |          |
|------------------|---------|--|----------|
|                  | Name    | Description                              | Version  |
| BLF8G09LS-400PW  | -       | earless flanged ceramic package; 8 leads | SOT1242B |
| BLF8G09LS-400PGW | -       | earless flanged ceramic package; 8 leads | SOT1242C |

## 4. Limiting values

**Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol    | Parameter            | Conditions | Min  | Max  | Unit |
|-----------|----------------------|------------|------|------|------|
| $V_{DS}$  | drain-source voltage |            | -    | 65   | V    |
| $V_{GS}$  | gate-source voltage  |            | -0.5 | +13  | V    |
| $T_{stg}$ | storage temperature  |            | -65  | +150 | °C   |
| $T_j$     | junction temperature | [1]        | -    | 225  | °C   |

[1] Continuous use at maximum temperature will affect the reliability, for details refer to the on-line MTF calculator.

## 5. Thermal characteristics

**Table 5. Thermal characteristics**

| Symbol        | Parameter                                | Conditions                                      | Typ  | Unit |
|---------------|--|---|------|------|
| $R_{th(j-c)}$ | thermal resistance from junction to case | $T_{case} = 80\text{ °C}$ ; $P_L = 95\text{ W}$ | 0.26 | K/W  |

## 6. Characteristics

**Table 6. DC characteristics**

$T_j = 25\text{ °C}$ ; per section unless otherwise specified.

| Symbol        | Parameter                        | Conditions  | Min | Typ  | Max | Unit |
|---------------|----------------------------------|---|-----|------|-----|------|
| $V_{(BR)DSS}$ | drain-source breakdown voltage   | $V_{GS} = 0\text{ V}$ ; $I_D = 3\text{ mA}$                       | 65  | -    | -   | V    |
| $V_{GS(th)}$  | gate-source threshold voltage    | $V_{DS} = 10\text{ V}$ ; $I_D = 300\text{ mA}$                    | 1.5 | 1.8  | 2.3 | V    |
| $V_{GSq}$     | gate-source quiescent voltage    | $V_{DS} = 28\text{ V}$ ; $I_D = 1700\text{ mA}$                   | 1.7 | 2    | 2.5 | V    |
| $I_{DSS}$     | drain leakage current            | $V_{GS} = 0\text{ V}$ ; $V_{DS} = 28\text{ V}$                    | -   | -    | 2.8 | μA   |
| $I_{DSX}$     | drain cut-off current            | $V_{GS} = V_{GS(th)} + 3.75\text{ V}$ ;<br>$V_{DS} = 10\text{ V}$ |     | 55   | -   | A    |
| $I_{GSS}$     | gate leakage current             | $V_{GS} = 11\text{ V}$ ; $V_{DS} = 0\text{ V}$                    | -   | -    | 280 | nA   |
| $g_{fs}$      | forward transconductance         | $V_{DS} = 10\text{ V}$ ; $I_D = 15\text{ A}$                      | -   | 26   | -   | S    |
| $R_{DS(on)}$  | drain-source on-state resistance | $V_{GS} = V_{GS(th)} + 3.75\text{ V}$ ;<br>$I_D = 12.25\text{ A}$ | -   | 0.06 | -   | Ω    |

**Table 7. RF characteristics**

Test signal: 2-carrier W-CDMA; PAR = 8.4 dB at 0.01 % probability on the CCDF; 3GPP test model 1; 1-64 DPCH;  $f_1 = 718.5\text{ MHz}$ ;  $f_2 = 723.5\text{ MHz}$ ;  $f_3 = 720.5\text{ MHz}$ ;  $f_4 = 725.5\text{ MHz}$ ; RF performance at  $V_{DS} = 28\text{ V}$ ;  $I_{Dq} = 3400\text{ mA}$ ;  $T_{case} = 25\text{ °C}$ ; unless otherwise specified; in a class-AB production test circuit, tested on straight lead device.

| Symbol      | Parameter                            | Conditions                | Min  | Typ  | Max | Unit |
|-------------|--------------------------------------|---------------------------|------|------|-----|------|
| $G_p$       | power gain                           | $P_{L(AV)} = 95\text{ W}$ | 18.8 | 20.6 | -   | dB   |
| $RL_{in}$   | input return loss                    | $P_{L(AV)} = 95\text{ W}$ | -    | -19  | -11 | dB   |
| $\eta_D$    | drain efficiency                     | $P_{L(AV)} = 95\text{ W}$ | 26   | 30   | -   | %    |
| $ACPR_{5M}$ | adjacent channel power ratio (5 MHz) | $P_{L(AV)} = 95\text{ W}$ | -    | -35  | -32 | dBc  |

## 7. Test information

### 7.1 Ruggedness in class-AB operation

The BLF8G09LS-400PW and BLF8G09LS-400PGW are capable of withstanding a load mismatch corresponding to VSWR = 7 : 1 through all phases under the following conditions:  $V_{DS} = 28$  V;  $I_{DQ} = 3400$  mA; 2-carrier W-CDMA signal;  $P_L = 200$  W;  $f = 716$  MHz; 5 MHz carrier spacing; 46 % clipping.

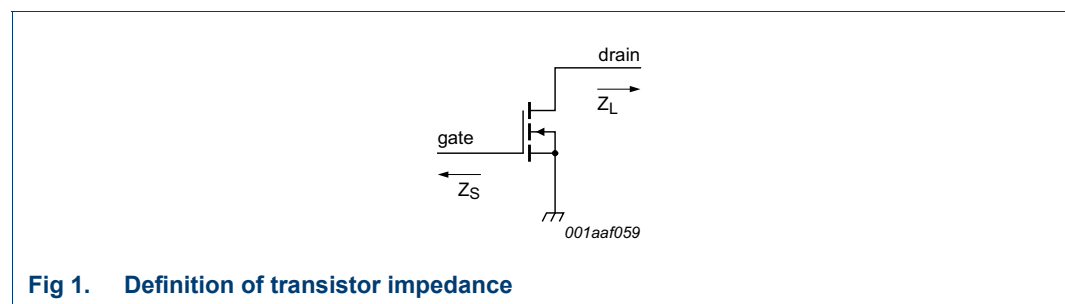
### 7.2 Impedance information

**Table 8. Typical impedance**

Measured load-pull data for the top-half of the push-pull package;  $I_{DQ} = 1800$  mA;  $V_{DS} = 28$  V;  $T_{case} = 25$  °C, water cooled.

| f<br>(MHz)                             | $Z_S$ <sup>[1]</sup><br>( $\Omega$ ) | $Z_L$ <sup>[1]</sup><br>( $\Omega$ ) |
|--|--------------------------------------|--------------------------------------|
| <b>BLF8G09LS-400PW (straight lead)</b> |                                      |                                      |
| 720                                    | 1.26 – j2.89                         | 1.8 – j1.94                          |
| 757                                    | 1.44 – j3.82                         | 2 – j1.6                             |
| 769                                    | 1.55 – j3.64                         | 1.9 – j1.75                          |
| 805                                    | 1.7 – j4.5                           | 1.5 – j1.3                           |
| <b>BLF8G09LS-400PGW (gull-wing)</b>    |                                      |                                      |
| 720                                    | 1.37 – j3                            | 1.7 – j2.1                           |
| 757                                    | 1.4 – j3.6                           | 1.6 – j2.3                           |
| 769                                    | 1.3 – j3.9                           | 1.7 – j2.2                           |
| 805                                    | 1.6 – j4.3                           | 1.48 – j1.97                         |

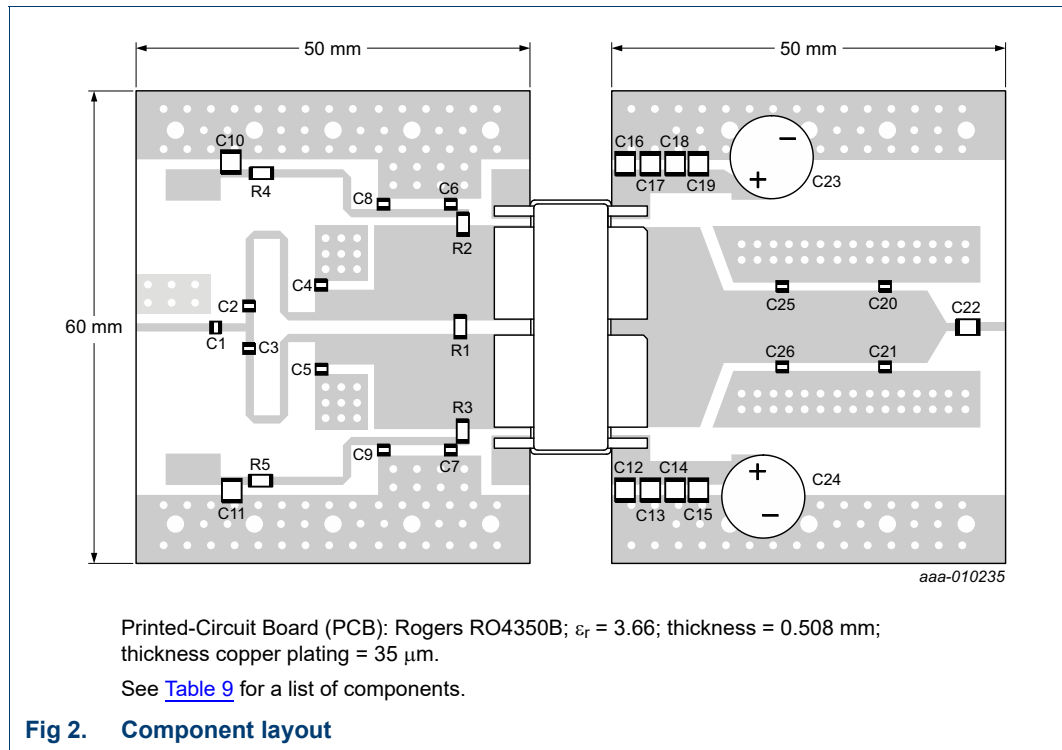
[1]  $Z_S$  and  $Z_L$  defined in [Figure 1](#).



### 7.3 VBW in class-AB operation

The BLF8G09LS-400PW and BLF8G09LS-400PGW show 45 MHz (typical) video bandwidth in class-AB test circuit in 722 MHz band at  $V_{DS} = 28$  V and  $I_{DQ} = 3400$  mA.

## 7.4 Test circuit



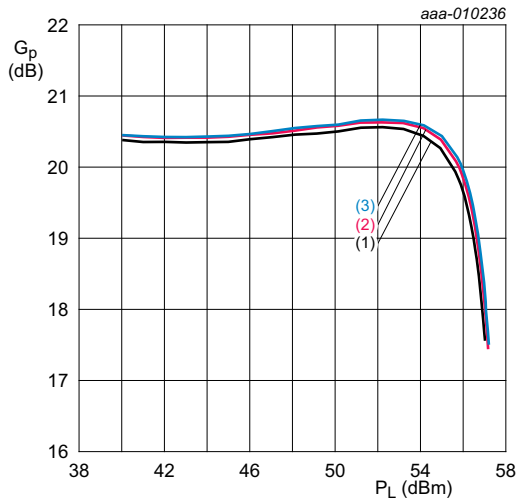
**Table 9. List of components**

For test circuit see [Figure 2](#).

| Component          | Description                       | Value                    | Remarks  |
|--------------------|-----------------------------------|--------------------------|----------|
| C1, C2, C3, C8, C9 | multilayer ceramic chip capacitor | 100 pF                   | ATC 100A |
| C4, C5             | multilayer ceramic chip capacitor | 9.1 pF                   | ATC 100A |
| C6, C7             | multilayer ceramic chip capacitor | 10 pF                    | ATC 100A |
| C10, C11, C13, C17 | multilayer ceramic chip capacitor | 1 $\mu\text{F}$ , 50 V   | Murata   |
| C12, C16           | multilayer ceramic chip capacitor | 100 nF, 50 V             | Murata   |
| C14, C15, C18, C19 | multilayer ceramic chip capacitor | 10 $\mu\text{F}$ , 50 V  | Murata   |
| C20, C21           | multilayer ceramic chip capacitor | 5.1 pF                   | ATC 100A |
| C22                | multilayer ceramic chip capacitor | 82 pF                    | ATC 100B |
| C23, C24           | electrolytic capacitor            | 470 $\mu\text{F}$ , 63 V |          |
| C25, C26           | multilayer ceramic chip capacitor | 3 pF                     | ATC 100A |
| R1                 | resistor                          | 10 $\Omega$              |          |
| R2, R3, R4, R5     | resistor                          | 5.1 $\Omega$             |          |

## 7.5 Graphical data

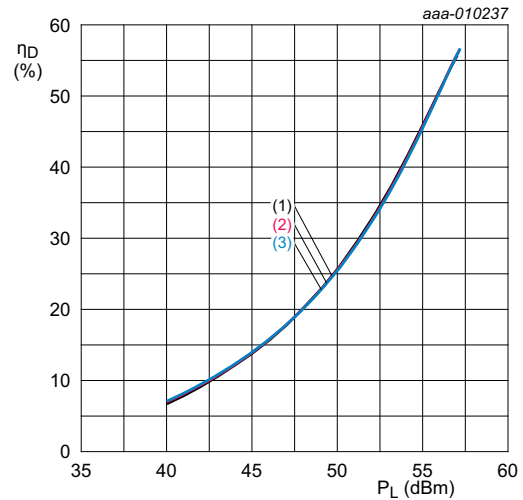
### 7.5.1 Pulsed CW



$V_{DS} = 28 \text{ V}$ ;  $I_{DQ} = 3400 \text{ mA}$ ;  $t_p = 100 \text{ } \mu\text{s}$ ;  $\delta = 10 \text{ } \%$ .

- (1)  $f = 716 \text{ MHz}$
- (2)  $f = 722 \text{ MHz}$
- (3)  $f = 728 \text{ MHz}$

**Fig 3. Power gain as a function of output power; typical values**

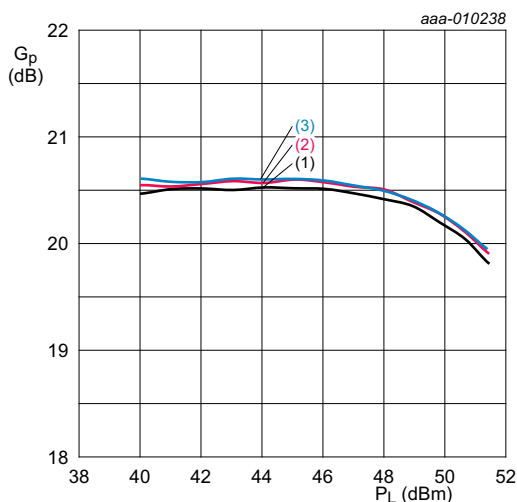


$V_{DS} = 28 \text{ V}$ ;  $I_{DQ} = 3400 \text{ mA}$ ;  $t_p = 100 \text{ } \mu\text{s}$ ;  $\delta = 10 \text{ } \%$ .

- (1)  $f = 716 \text{ MHz}$
- (2)  $f = 722 \text{ MHz}$
- (3)  $f = 728 \text{ MHz}$

**Fig 4. Drain efficiency as a function of output power; typical values**

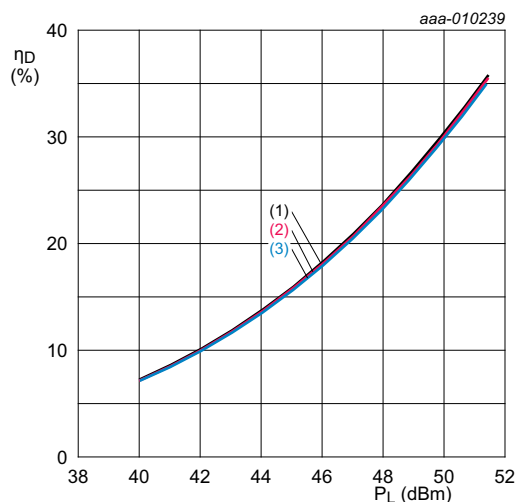
## 7.5.2 IS-95



$V_{DS} = 28 \text{ V}; I_{DQ} = 3400 \text{ mA}$ .

- (1)  $f = 716 \text{ MHz}$
- (2)  $f = 722 \text{ MHz}$
- (3)  $f = 728 \text{ MHz}$

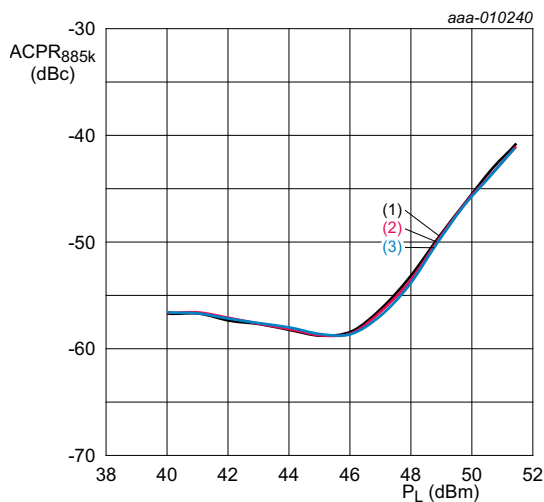
**Fig 5. Power gain as a function of output power; typical values**



$V_{DS} = 28 \text{ V}; I_{DQ} = 3400 \text{ mA}$ .

- (1)  $f = 716 \text{ MHz}$
- (2)  $f = 722 \text{ MHz}$
- (3)  $f = 728 \text{ MHz}$

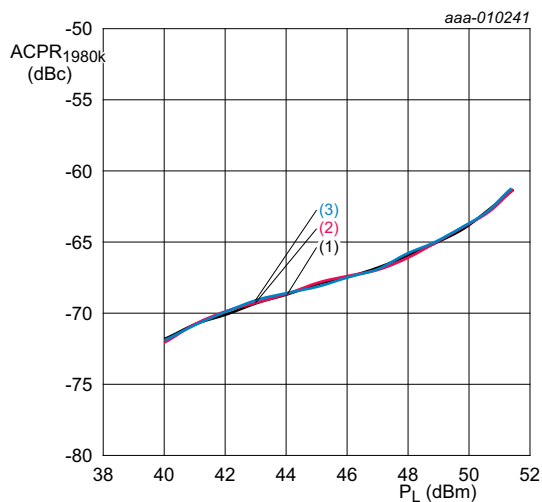
**Fig 6. Drain efficiency as a function of output power; typical values**



$V_{DS} = 28 \text{ V}; I_{DQ} = 3400 \text{ mA}$ .

- (1)  $f = 716 \text{ MHz}$
- (2)  $f = 722 \text{ MHz}$
- (3)  $f = 728 \text{ MHz}$

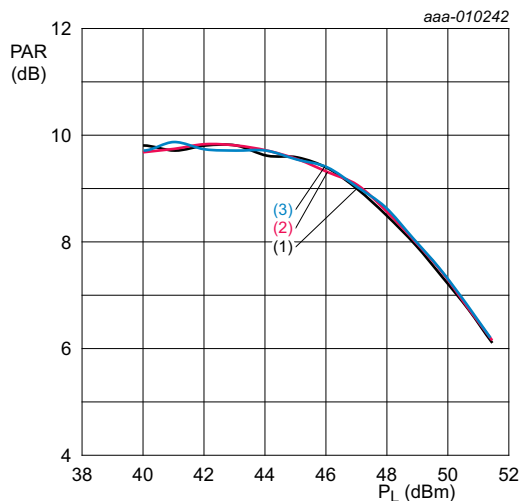
**Fig 7. Adjacent channel power ratio (885 kHz) as a function of output power; typical values**



$V_{DS} = 28 \text{ V}; I_{DQ} = 3400 \text{ mA}$ .

- (1)  $f = 716 \text{ MHz}$
- (2)  $f = 722 \text{ MHz}$
- (3)  $f = 728 \text{ MHz}$

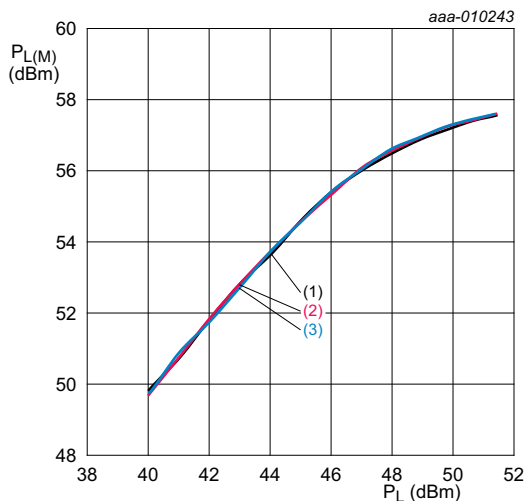
**Fig 8. Adjacent channel power ratio (1980 kHz) as a function of output power; typical values**



$V_{DS} = 28 \text{ V}$ ;  $I_{Dq} = 3400 \text{ mA}$ .

- (1)  $f = 716 \text{ MHz}$
- (2)  $f = 722 \text{ MHz}$
- (3)  $f = 728 \text{ MHz}$

**Fig 9. Peak-to-average ratio as a function of output power; typical values**

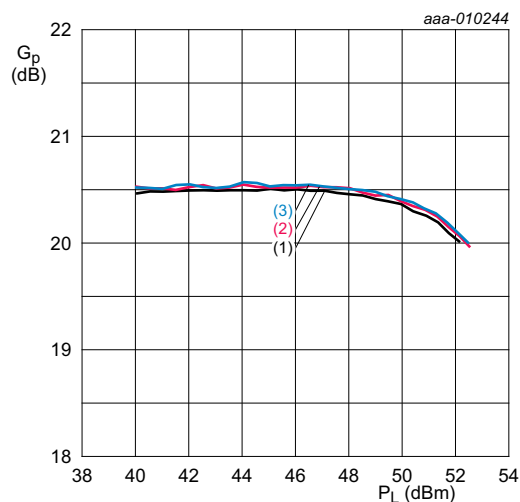


$V_{DS} = 28 \text{ V}$ ;  $I_{Dq} = 3400 \text{ mA}$ .

- (1)  $f = 716 \text{ MHz}$
- (2)  $f = 722 \text{ MHz}$
- (3)  $f = 728 \text{ MHz}$

**Fig 10. Peak output power as a function of output; typical values**

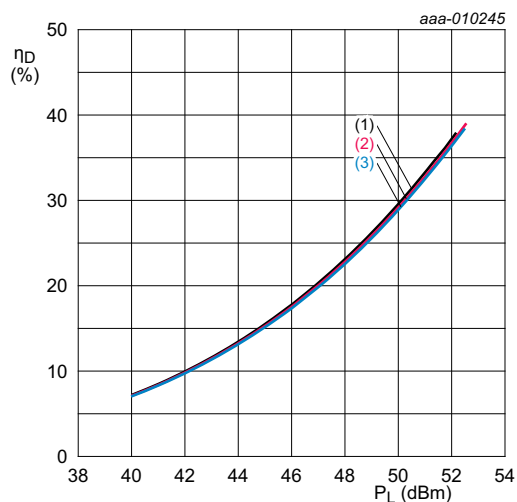
### 7.5.3 1-Carrier W-CDMA



$V_{DS} = 28 \text{ V}$ ;  $I_{Dq} = 3400 \text{ mA}$ .

- (1)  $f = 716 \text{ MHz}$
- (2)  $f = 722 \text{ MHz}$
- (3)  $f = 728 \text{ MHz}$

**Fig 11. Power gain as a function of output power; typical values**

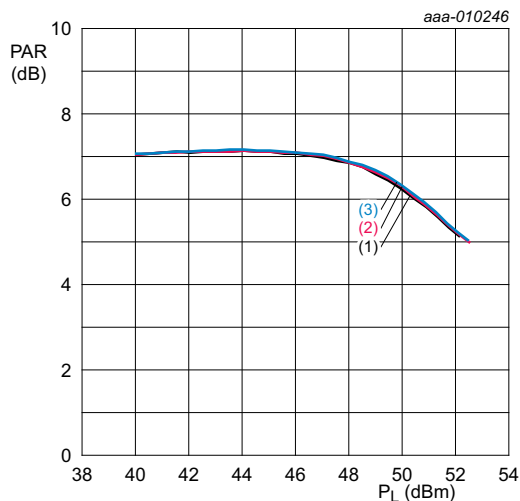


$V_{DS} = 28 \text{ V}$ ;  $I_{Dq} = 3400 \text{ mA}$ .

- (1)  $f = 716 \text{ MHz}$
- (2)  $f = 722 \text{ MHz}$
- (3)  $f = 728 \text{ MHz}$

**Fig 12. Drain efficiency as a function of output power; typical values**

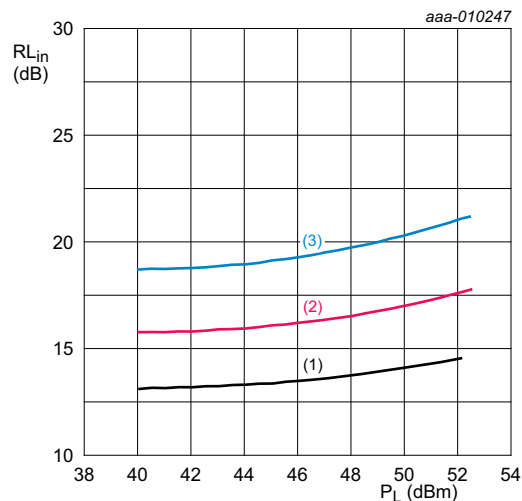




$V_{DS} = 28$  V;  $I_{Dq} = 3400$  mA.

- (1)  $f = 716$  MHz
- (2)  $f = 722$  MHz
- (3)  $f = 728$  MHz

**Fig 13. Peak-to-average ratio as a function of output power; typical values**

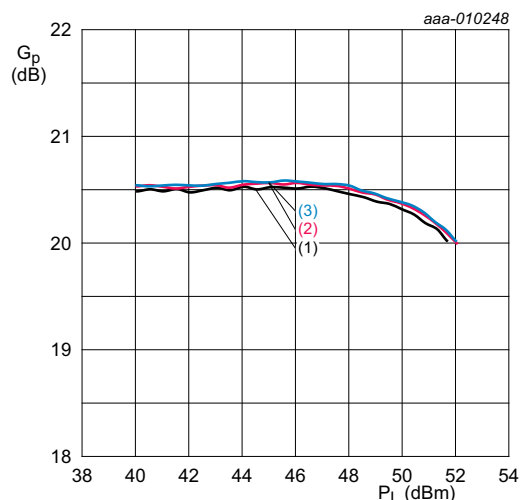


$V_{DS} = 28$  V;  $I_{Dq} = 3400$  mA.

- (1)  $f = 716$  MHz
- (2)  $f = 722$  MHz
- (3)  $f = 728$  MHz

**Fig 14. Input return loss as a function of output power; typical values**

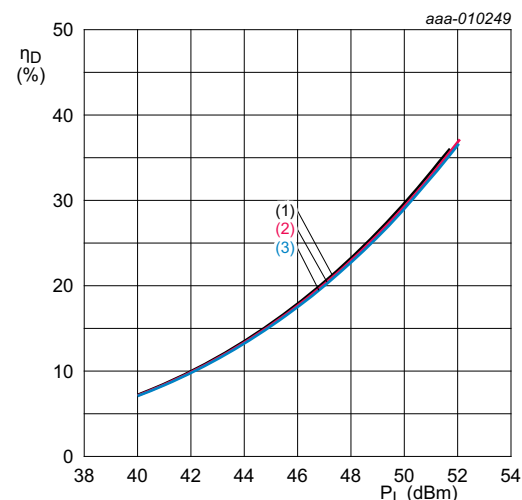
#### 7.5.4 2-Carrier W-CDMA



$V_{DS} = 28$  V;  $I_{Dq} = 3400$  mA.

- (1)  $f = 716$  MHz
- (2)  $f = 722$  MHz
- (3)  $f = 728$  MHz

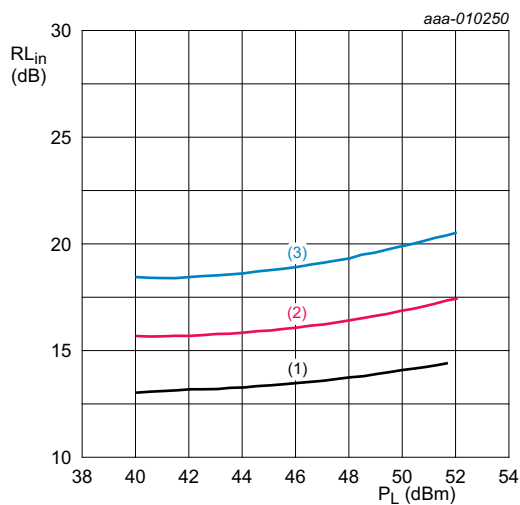
**Fig 15. Power gain as a function of output power; typical values**



$V_{DS} = 28$  V;  $I_{Dq} = 3400$  mA.

- (1)  $f = 716$  MHz
- (2)  $f = 722$  MHz
- (3)  $f = 728$  MHz

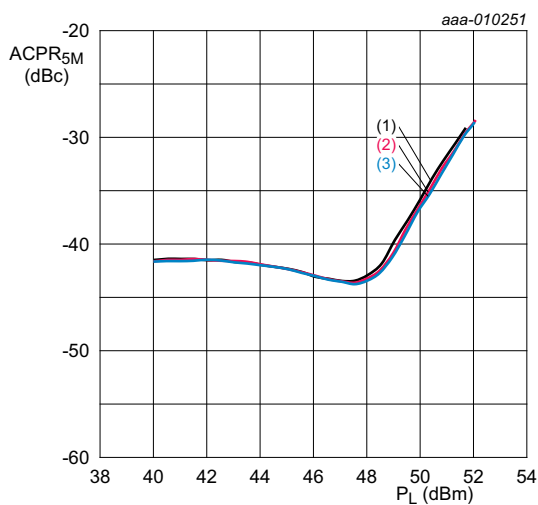
**Fig 16. Drain efficiency as a function of output power; typical values**



$V_{DS} = 28 \text{ V}$ ;  $I_{DQ} = 3400 \text{ mA}$ .

- (1)  $f = 716 \text{ MHz}$
- (2)  $f = 722 \text{ MHz}$
- (3)  $f = 728 \text{ MHz}$

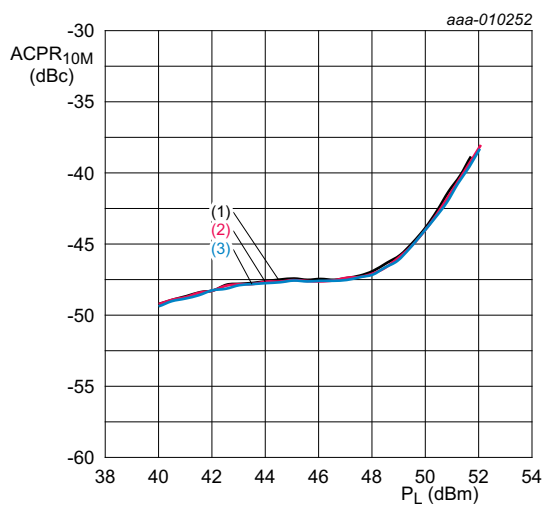
Fig 17. Input return loss as a function of output power; typical values



$V_{DS} = 28 \text{ V}$ ;  $I_{DQ} = 3400 \text{ mA}$ .

- (1)  $f = 716 \text{ MHz}$
- (2)  $f = 722 \text{ MHz}$
- (3)  $f = 728 \text{ MHz}$

Fig 18. Adjacent channel power ratio (5 MHz) as a function of output power; typical values

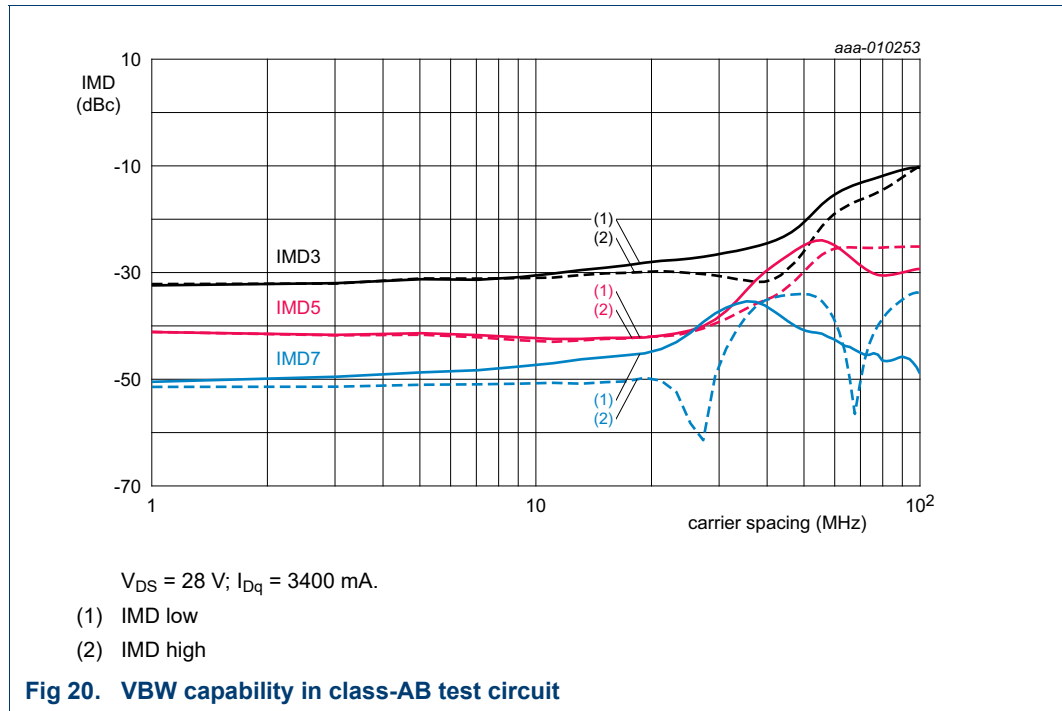


$V_{DS} = 28 \text{ V}$ ;  $I_{DQ} = 3400 \text{ mA}$ .

- (1)  $f = 716 \text{ MHz}$
- (2)  $f = 722 \text{ MHz}$
- (3)  $f = 728 \text{ MHz}$

Fig 19. Adjacent channel power ratio (10 MHz) as a function of output power; typical values

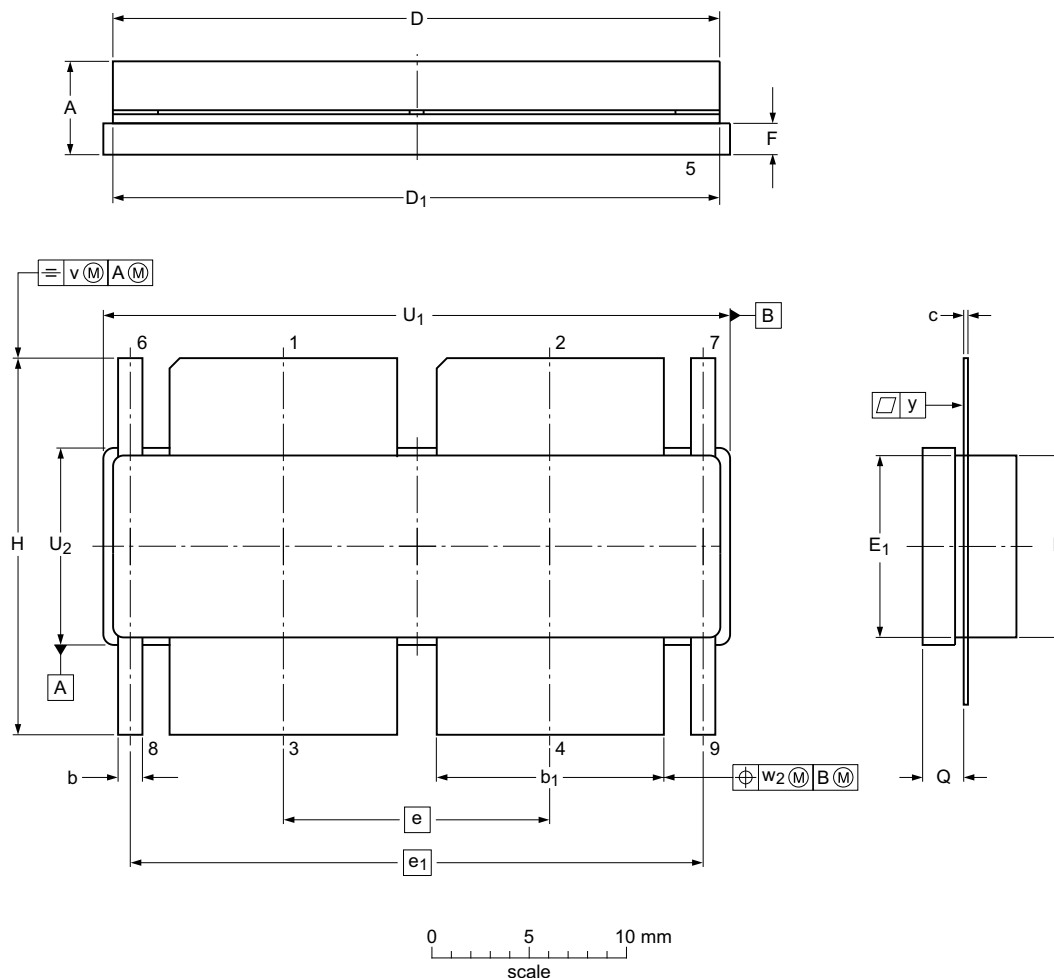
### 7.5.5 2-Tone VBW



## 8. Package outline

Earless flanged ceramic package; 8 leads

SOT1242B



### Dimensions

| Unit <sup>(1)</sup> | A   | b     | b <sub>1</sub> | c     | D     | D <sub>1</sub> | e     | e <sub>1</sub> | E     | E <sub>1</sub> | F     | H     | Q <sup>(2)</sup> | U <sub>1</sub> | U <sub>2</sub> | v     | w <sub>2</sub> | y     |
|---------------------|-----|-------|----------------|-------|-------|----------------|-------|----------------|-------|----------------|-------|-------|------------------|----------------|----------------|-------|----------------|-------|
| mm                  | max | 5.5   | 1.41           | 11.81 | 0.18  | 31.55          | 31.52 |                | 9.50  | 9.53           | 1.75  | 19.94 | 2.26             | 32.39          | 10.29          | 0.25  | 0.25           | 0.10  |
|                     | nom |       |                |       |       |                | 13.72 | 29.47          |       |                |       |       |                  |                |                |       |                |       |
|                     | min | 4.2   | 1.14           | 11.56 | 0.10  | 30.94          | 30.96 |                | 9.30  | 9.27           | 1.50  | 18.92 | 2.01             | 32.13          | 10.03          |       |                |       |
| inches              | max | 0.217 | 0.055          | 0.465 | 0.007 | 1.242          | 1.241 |                | 0.374 | 0.375          | 0.069 | 0.785 | 0.089            | 1.275          | 0.405          | 0.010 | 0.010          | 0.004 |
|                     | nom |       |                |       |       |                | 0.540 | 1.16           |       |                |       |       |                  |                |                |       |                |       |
|                     | min | 0.165 | 0.045          | 0.455 | 0.004 | 0.218          | 1.219 |                | 0.366 | 0.365          | 0.059 | 0.745 | 0.079            | 1.265          | 0.395          |       |                |       |

### Note

1. Millimeter dimensions are derived from the original inch dimensions.
2. Dimension is measured 0.030 inch (0.76 mm) from the body.

sot1242b\_po

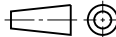
| Outline version | References |       |       |  | European projection   | Issue date           |
|-----------------|------------|-------|-------|--|---|----------------------|
|                 | IEC        | JEDEC | JEITA |  |   |                      |
| SOT1242B        |            |       |       |  |  | 12-11-28<br>15-07-21 |

Fig 21. Package outline SOT1242B

Earless flanged ceramic package; 8 leads

SOT1242C

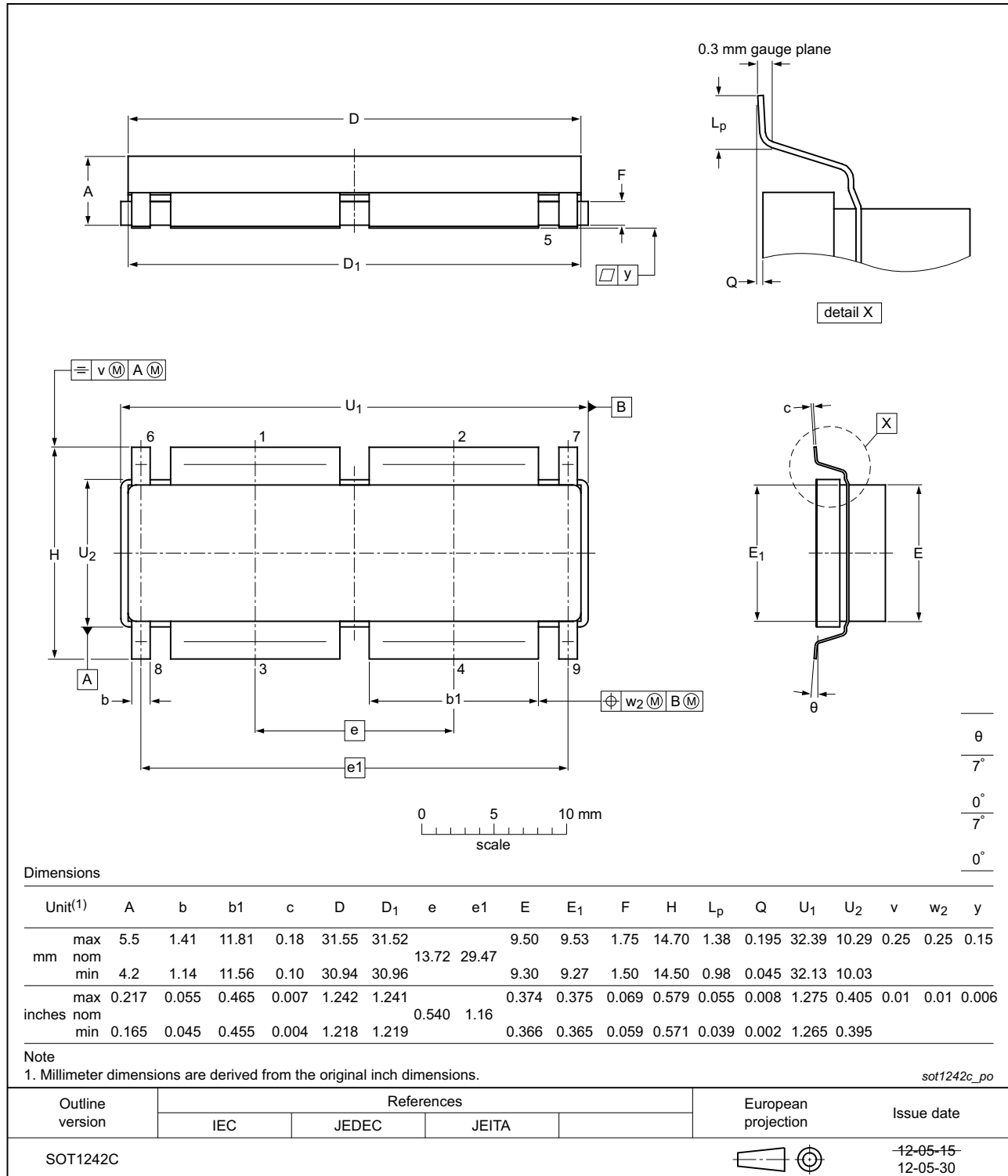


Fig 22. Package outline SOT1242C

## 9. Handling information

### CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the *ANSI/ESD S20.20*, *IEC/ST 61340-5*, *JESD625-A* or equivalent standards.

## 10. Abbreviations

Table 10. Abbreviations

| Acronym | Description                                    |
|---------|--|
| 3GPP    | 3rd Generation Partnership Project             |
| CCDF    | Complementary Cumulative Distribution Function |
| CW      | Continuous Wave                                |
| DPCH    | Dedicated Physical CHannel                     |
| ESD     | ElectroStatic Discharge                        |
| IS-95   | Interim Standard 95                            |
| LDMOS   | Laterally Diffused Metal Oxide Semiconductor   |
| MTF     | Median Time to Failure                         |
| PAR     | Peak-to-Average Ratio                          |
| VBW     | Video Bandwidth                                |
| VSWR    | Voltage Standing Wave Ratio                    |
| W-CDMA  | Wideband Code Division Multiple Access         |

## 11. Revision history

Table 11. Revision history

| Document ID                       | Release date   | Data sheet status      | Change notice | Supersedes                        |
|-----------------------------------|--|------------------------|---------------|-----------------------------------|
| BLF8G09LS-400PW_8G09LS-400PGW#5   | 20150901   | Product data sheet     | -             | BLF8G09LS-400PW_8G09LS-400PGW v.4 |
| Modifications:                    | <ul style="list-style-type: none"> <li>The format of this document has been redesigned to comply with the new identity guidelines of Ampleon.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul> |                        |               |                                   |
| BLF8G09LS-400PW_8G09LS-400PGW v.4 | 20150728   | Product data sheet     | -             | BLF8G09LS-400PW_8G09LS-400PGW v.3 |
| BLF8G09LS-400PW_8G09LS-400PGW v.3 | 20140324   | Product data sheet     | -             | BLF8G09LS-400PW_8G09LS-400PGW v.2 |
| BLF8G09LS-400PW_8G09LS-400PGW v.2 | 20131220   | Preliminary data sheet | -             | BLF8G09LS-400PW_8G09LS-400PGW v.1 |
| BLF8G09LS-400PW_8G09LS-400PGW v.1 | 20130927   | Objective data sheet   | -             | -                                 |

## 12. Legal information

### 12.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition  |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.ampleon.com>.

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